

| L Number | Hits | Search Text | DB | Time stamp |
|----------|------|--|---|------------------|
| 1 | 385 | (365/52).CCLS. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/22 11:20 |
| - | 9386 | ((multi-chip) or multi?chip) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/21 09:45 |
| - | 0 | ((multi-chip) or multi?chip)) and correspond\$3 with (address adj pad and data adj pad and control adj signal adj pad) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/17 19:23 |
| - | 2 | ((multi-chip) or multi?chip)) and (address adj pad and data adj pad and control adj signal adj pad) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/17 19:25 |
| - | 9 | address adj pad and data adj pad and control adj signal adj pad | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/17 19:28 |
| - | 1 | internal adj connection with control adj signal adj pad | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/20 08:26 |
| - | 37 | ((multi-chip) or multi?chip)) and common adj package | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/17 19:33 |
| - | 2052 | (365/51,63).CCLS. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/20 08:25 |
| - | 49 | ((multi-chip) or multi?chip)) and ((365/51,63).CCLS.) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/17 19:33 |
| - | 2052 | (365/51,63).CCLS. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/22 11:20 |
| - | 0 | ((365/51,63).CCLS.) and (internal adj connection with control adj signal) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/20 08:26 |
| - | 59 | internal adj connection with control adj signal | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/20 11:01 |

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|---|------|---|---|------------------|
| - | 2 | ("6023077").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/20 11:01 |
| - | 9394 | multi-chip | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/21 16:12 |
| - | 11 | multi-chip and integrated and data adj pads | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/21 16:14 |
| - | 17 | multi-chip and data adj pads | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/21 16:13 |
| - | 13 | multi-chip and data adj pads | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/21 16:13 |
| - | 13 | multi-chip and data adj pads | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/21 16:14 |
| - | 2470 | multi-chip and integrated and data | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/21 16:14 |
| - | 2464 | multi-chip and integrated and data | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/21 16:15 |
| - | 2389 | (multi-chip and integrated and data) and between | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/21 16:15 |
| - | 388 | ((multi-chip and integrated and data) and between) and encapsulat\$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/21 16:15 |
| - | 285 | ((((multi-chip and integrated and data) and between) and encapsulat\$3) and package | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/21 16:16 |
| - | 45 | (((((multi-chip and integrated and data) and between) and encapsulat\$3) and package) and internal with connect\$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/10/21 16:16 |